Filename: PMP2967\_REVA\_bom.xls

Date: 10/19/2007 updated November 1, 2007: updates are RED and BOLD

## PMP2967\_REVA BOM

COUNT	RefDes	Value	Description	Size	Part Number	Mfr AREA	
1	C1	100uF	Capacitor, Aluminum, 100-µF, 63-V, 20%		EEVFK1J101P	Panasonic	
1	C10	.033uF	Capacitor, Ceramic, 0.033uF, 50-V, X7R, 15%	0603	Std	Std	
	C102, C103, C104,						
4	C105	10uF	Capacitor, Ceramic, xxx-uF, vv-V, [temp], [tol]	1206	ECJ-3YB1E106M	Panasonic	
	C106, C107, C108,						
4	C109	0.1uF	Capacitor, Ceramic, 0.1-uF, 16-V, X7R	0603	ECJ-1VB1C104K	Panasonic	
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4	C11, C12, C13, C15	47uF	Capacitor, Ceramic, 47-uF, 10-V, X5R, 15%	1210		Panasonic	
2	C110, C111	0.01uF	Capacitor, Ceramic, 25V, X7R, 20%	0603	std	std	
1	C16	2200pF	Capacitor, Ceramic, 2200-pF, 50-V, X7R, 15%	0603	Std	Std	
1	C17	0.1uF	Capacitor, Ceramic, 0.1-uF, 50-V, X7R, 15%	0603	Std	Std	
1	C18	1uF	Capacitor, Ceramic, 1-uF, 16-V, X7R, 15%	0603	Std	Std	
1	C19	OPEN	Capacitor, Ceramic, open	0603	Std	Std	
2	C2, C14	1000pF	Capacitor, Ceramic, 250V, X7R, 15%	0603	Std	TDK	
1	C20	0.047uF	Capacitor, Ceramic, 0.047-uF, 25-V, X7R, 15%	0603	Std	Std	
1	C21	.1uF	Capacitor, Ceramic, .1uF, 16V, X7R, 10%	0805	Std	Std	
1	C22	470pF	Capacitor, Ceramic, 470pF, 50-V, X7R, 15%	0603	Std	Std	
1	C23	0.022uF	Capacitor, Ceramic, 0.022-uF, 50-V, X7R, 15%	0603	Std	Std	
2	C25, C28	0.1uF	Capacitor, Ceramic, 250V, X7R, 15%	1206	Std	TDK	
1	C27	1uF	Capacitor, Ceramic, 250V, X7R, 15%	2220	Std	TDK	
2	C3, C6	1000uF	Capacitor, Aluminum Electrolytic, 50V	0.571 inch	50ZL1000	Rubycon	
2	C4, C5	3.3uF	Capacitor, Ceramic, 3.3uF, 50-V, X7R, 15%	1210	C3225X7R1H335K		
1	C7	100pF	Capacitor, Ceramic, 100pF, 50V, NPO, 10%	0603	Std	Std	
1	C8	.1uF	Capacitor, Ceramic, 50V, X7R, 10%	0805	Std	Std	
3	C9, C24, C26	0.47uF	Capacitor, Ceramic, 250V, X7R, 15%	1812	Std	TDK	
1	D1	BAS16	Diode, Switching, 150-mA, 75-V, 350mW	SOT23	BAS16	Vishay-Liteon	
2	D101, D102	Green	Diode, LED, Green, 2.1-V, 20-mA, 6-mcd	0603	160-1183-1-ND	Liteon	
1	D103	Red	Diode, LED, Red, 1.8-V, 20-mA, 20-mcd	0603	160-1181-1-ND	Liteon	
1	D11	MBRD1035	Diode, Schottky, 10-A, 35-V	DPAK	MBRD1035	On Semi	
1	D2	SMCJ100CA	Diode, Transient Voltage Suppressor, 600W, 100V	D0-214AA	SMCJ100CA	Diodes	
1	D3	12V	Diode, Zener, 12-V, 350-mW	SOT-23	BZX84C12VT	Diodes	
3	D4, D7, D10	MMBD1401	Diode, 200-V, 200-mA, 300-mW	SOT23	MMBD1401	Fairchild	
3	D5, D6, D9	18V	Diode, Zener, 18-V, 350-mW	SOT-23	BZX84C18VT	Diodes	
1	D8	39V	Diode, Zener, 39-V, 350-mW	SOT-23	BZX84C39VT	Diodes	
1	F1	10A, 125V	SMF, Very Fast Acting Type Fuse, Nano Series	0.106 x 0.240 i		Little Fuse	
1	FB1	25F03032T010	Jumper used for initial Dallas testing		r 25F03032T010	Steward	
1	J1	D120/3DS	D120/3DS	Terminal Block		0.60 x 0.35 inch	
1	J102	D120/3DS	D120/4DS	Terminal Block		0.80 x 0.35 inch	
2	J2, J3	D120/7D0	ED1609	Terminal Block	•	0.40 x 0.35 ""	
_	02, 00		LD 1000	reminal block	, 001	0.70 \ 0.00	

IO( Vishay Sumida C Sumida D2-Pak DPAK NI) PWRPAK S0-8 SOT23 SOT23 SOP-8 603
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TP2, TP4, TP102, TP109, TP111, TP1, TP5, TP6, 10 TP9, TP10 5000 5000 Test Point, RecKeystone 0.100 x 0.100 inch TP3, TP11, TP108, TP110, TP7, TP8 Test Point, BlacKeystone 5001 5001 0.100 x 0.100 inch IC, Dual Op Am TI U1 TLC272AD TLC272xD SO8 U100 **TPS40054PWP** TPS40054PWP IC, Wide Input {Texas Instruments PWP16 RHL-20 bq24120RHL U2 bq24120 IC, Advanced Li -lon and Li-Pol Charge Management ΤI

- Notes: 1. These assemblies are ESD sensitive, ESD precautions shall be observed.
  - 2. These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
  - 3. These assemblies must comply with workmanship standards IPC-A-610 Class 2.
  - 4. Ref designators marked with an asterisk ('\*\*') cannot be substituted. All other components can be substituted with equivalent MFG's components.

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